

JY09M

N Channel Enhancement Mode Power MOSFET

GENERAL DESCRIPTION

The JY09M utilizes the latest trench processing techniques to achieve the high cell density and reduces the on-resistance with low gate charge. These features combine to make this design an extremely efficient and reliable device for use in power switching application and a wide variety of other applications.

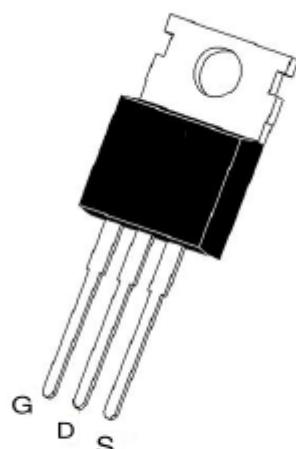
FEATURES

- 70V/90A, $R_{DS(ON)} \leq 6.8\text{m}\Omega$ @ $V_{GS}=10\text{V}$
- Fast switching and reverse body recovery
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

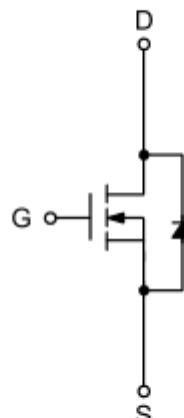
APPLICATIONS

- Power Switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

PIN DESCRIPTION



TO-220



N-Channel MOSFET

JY09M

Absolute Maximum Ratings($T_c=25^\circ C$ Unless Otherwise Noted)

Symbol	Parameter		Limit	Unit
V_{DS}	Drain-Source Voltage		70	V
V_{GS}	Gate-Source Voltage		± 20	V
I_D	Continuous Drain Current	$T_c=25^\circ C$	90	A
		$T_c=100^\circ C$	65	
I_{DM}	Pulsed Drain Current		315	A
P_D	Maximum Power Dissipation		162	W
$T_J T_{STG}$	Operating Junction and Storage Temperature Range		-55 to +175	$^\circ C$
$R_{\theta JC}$	Thermal Resistance-Junction to Case		0.85	$^\circ C/W$
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient		62.5	$^\circ C/W$

Electrical Characteristics($T_a=25^\circ C$ Unless Otherwise Noted)

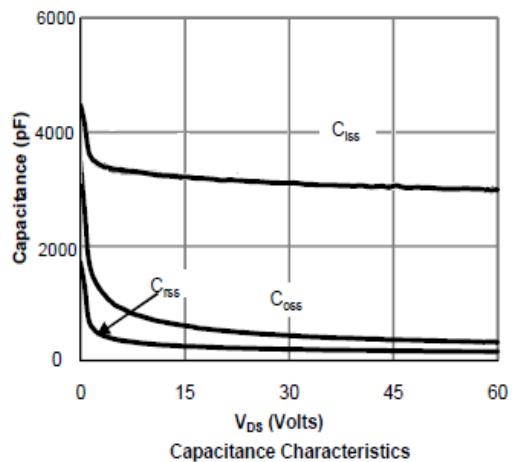
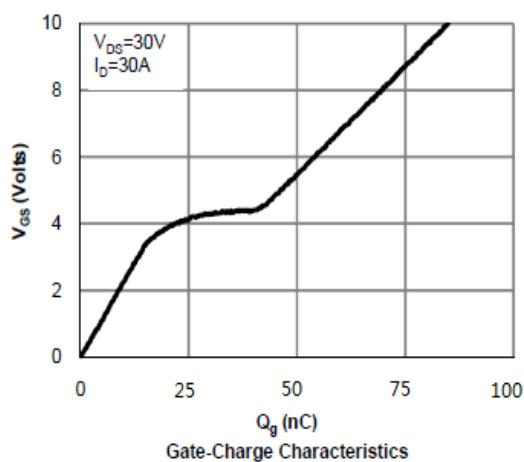
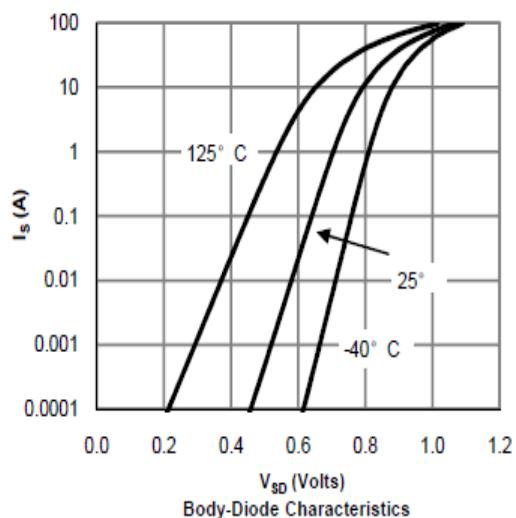
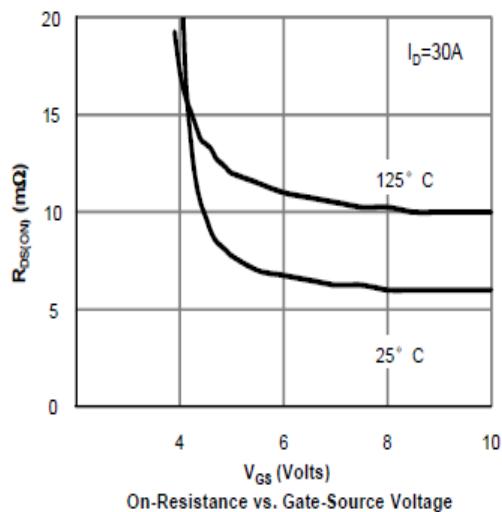
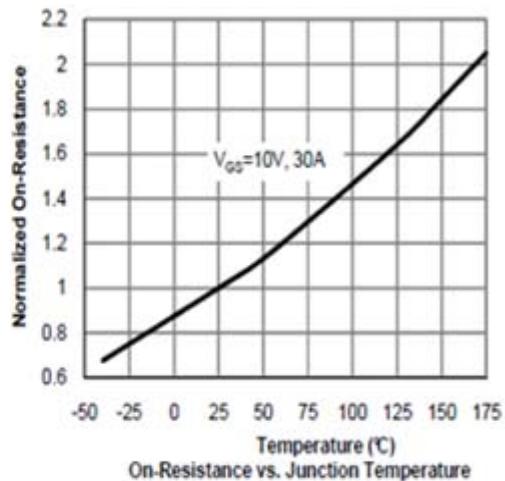
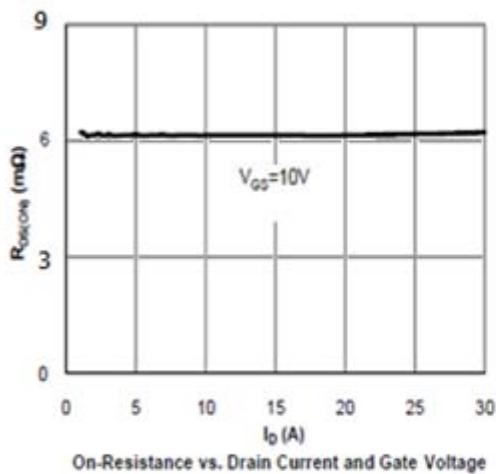
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	70			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=70V, V_{GS}=0V$			1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	2		4	V
$R_{DS(ON)}$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=30A$		6.0	6.8	$m\Omega$

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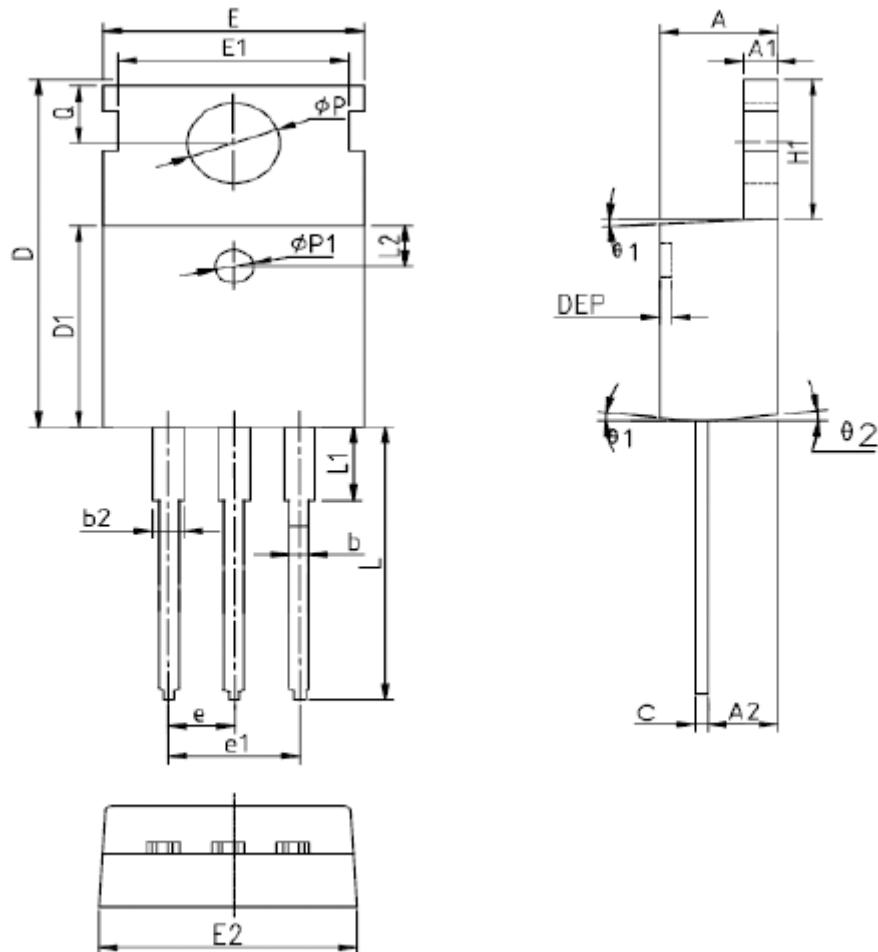
Electrical Characteristics(T_a=25°C Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Drain-Source Diode Characteristics						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _{SD} =30A			1.3	V
Tr _r	Reverse Recovery Time	I _{SD} =30A di/dt=100A/us		35		ns
Q _{rr}	Reverse Recovery Charge			50		nC
Dynamic Characteristics						
T _{d(on)}	Turn-on Delay Time	V _{DS} =30V, R _G =3Ω, I _{DS} =30A, V _{GS} =10V,		15		ns
Tr	Turn-on Rise Time			12		
T _{d(off)}	Turn-off Delay Time			50		
T _f	Turn-off Fall Time			14		
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =30V, f=1.0MHz		3215		pF
C _{oss}	Output Capacitance			345		
C _{RSS}	Reverse Transfer Capacitance			230		
Q _g	Total Gate Charge	V _{DS} =30V, I _D =30A, V _{GS} =10V		86		nC
Q _{gs}	Gate-Source Charge			19		
Q _{gd}	Gate-Drain Charge			25		

Typical electrical and thermal characteristics



TO220-3 Package Outline



SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	4.40	4.57	4.70	0.173	0.180	0.185	θp1	1.40	1.50	1.60	0.055	0.059	0.063
A1	1.27	1.30	1.33	0.050	0.051	0.052	e	2.54BSC			0.1BSC		
A2	2.35	2.40	2.50	0.093	0.094	0.098	e1	5.08BSC			0.2BSC		
b	0.77	-	0.90	0.030	-	0.035	H1	6.40	6.50	6.60	0.252	0.256	0.260
b2	1.23	-	1.36	0.048	-	0.054	L	12.75	-	13.17	0.502	-	0.519
C	0.48	0.50	0.52	0.019	0.020	0.021	L1	-	-	3.95	-	-	0.156
D	15.40	15.60	15.80	0.606	0.614	0.622	L2	2.50REF.			0.098REF.		
D1	9.00	9.10	9.20	0.354	0.358	0.362	θp	3.57	3.60	3.63	0.141	0.142	0.143
DEP	0.05	0.10	0.20	0.002	0.004	0.008	Q	2.73	2.80	2.87	0.107	0.110	0.113
E	9.70	9.90	10.10	0.382	0.389	0.398	θ 1	5°	7°	9°	5°	7°	9°
E1	-	8.70	-	-	0.343	-	θ 2	1°	3°	5°	1°	3°	5°
E2	9.80	10.00	10.20	0.386	0.394	0.401							